



60V PNP SURFACE MOUNT SMALL SIGNAL TRANSISTOR IN SOT23

Features

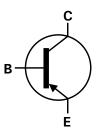
- Epitaxial Planar Die Construction
- Complementary NPN Type Available (MMBT2222A)
- Ideal for Low Power Amplification and Switching
- Lead Free, RoHS Compliant (Note 1)
- Halogen and Antimony Free "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

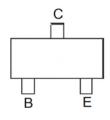
- Case: SOT23
- Case Material: molded Plastic, "Green" Compound
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish
- Weight: 0.008 grams (approximate)







Device Symbol



Top View Pin-Out

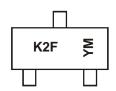
Ordering Information (Note 3 & 4)

Product	Grade	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
MMBT2907A-7-F	Commercial	K2F	7	8	3,000
MMBT2907A-13-F	Commercial	K2F	13	8	10,000
MMBT2907AQ-7-F	Automotive	K2F	7	8	3,000

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com
- 3. For packaging details, go to our website at http://www.diodes.com.
- 4. Products with Q-suffix are automotive grade. Automotive products are electrical and thermal the same as the commercial, except where specified

Marking Information



K2F = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

Date Code Key

Year	2010	20	011	2012	2	2013	2014		2015	2016		2017
Code	X		Υ	Z		Α	В		С	D		E
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-60	V
Collector-Emitter Voltage	V _{CEO}	-60	V
Emitter-Base Voltage	V_{EBO}	-5.0	V
Collector Current - Continuous	Ic	-600	mA
Peak Collector Current	Ісм	-800	mA

Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	300	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	417	°C/W
Thermal Resistance, Junction to Lead (Note 6)	$R_{ heta JL}$	350	°C/W
Operating and Storage and Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes:

- 5. For a device surface mounted on minimum recommended pad layout FR4 PCB with high coverage of single sided 1oz copper in still air conditions; the device is measured when operating in a steady-state condition.
- 6. Thermal resistance from junction to solder-point (at the end of the collector lead).

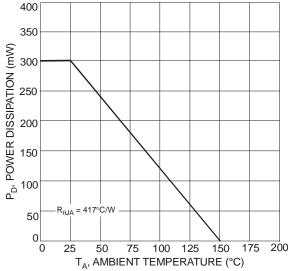


Fig. 1 Power Dissipation vs. Ambient Temperature



Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)						
Collector-Base Breakdown Voltage	V _{(BR)CBO}	-60	_	V	$I_C = -10\mu A, I_E = 0$	
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	-60	_	V	$I_C = -10 \text{mA}, I_B = 0$	
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	-5.0		V	$I_E = -10\mu A, I_C = 0$	
Collector Cutoff Current	1		-10	nA	$V_{CB} = -50V, I_{E} = 0$	
Collector Cutoff Current	Ісво	_	-10	μΑ	$V_{CB} = -50V$, $I_E = 0$, $T_A = 125$ °C	
Collector Cutoff Current	I _{CEX}	_	-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -0.5V$	
Base Cutoff Current	I_{BL}		-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -0.5V$	
ON CHARACTERISTICS (Note 7)						
		75	_		$I_C = -100 \mu A, V_{CE} = -10 V$	
		100	_		$I_C = -1.0 \text{mA}, V_{CE} = -10 \text{V}$	
DC Current Gain	h _{FE}	100	_	_	$I_C = -10 \text{mA}, V_{CE} = -10 \text{V}$	
		100 50	300		$I_C = -150 \text{mA}, V_{CE} = -10 \text{V}$	
		50			$I_C = -500 \text{mA}, V_{CE} = -10 \text{V}$	
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	_	-0.4	V	$I_C = -150 \text{mA}, I_B = -15 \text{mA}$	
Constitution Canadanian Fortage	VCE(SAT)		-1.6		$I_C = -500 \text{mA}, I_B = -50 \text{mA}$	
Base-Emitter Saturation Voltage	V _{BE(SAT)}	_	-1.3 -2.6	V	$I_C = 150 \text{mA}, I_B = 15 \text{mA}$	
				•	$I_C = 500 \text{mA}, I_B = 50 \text{mA}$	
SMALL SIGNAL CHARACTERISTICS				ı	1	
Output Capacitance	C _{obo}		8.0	pF	$V_{CB} = -10V, f = 1.0MHz, I_E = 0$	
Input Capacitance	C _{ibo}		30	pF	$V_{EB} = -2.0V$, $f = 1.0MHz$, $I_C = 0$	
Current Gain-Bandwidth Product	f⊤	200		MHz	$V_{CE} = -20V, I_{C} = -50mA,$ f = 100MHz	
SWITCHING CHARACTERISTICS				-		
Turn-On Time	t _{off}	_	45	ns		
Delay Time	t _d		10	ns	$V_{CC} = -30V$, $I_{C} = -150mA$,	
Rise Time	t _r		40	ns	$I_{B1} = -15 \text{mA}$	
Turn-Off Time	t _{off}		100	ns	V COV I 450A	
Storage Time	ts		80	ns	$V_{CC} = -6.0V$, $I_{C} = -150mA$, $I_{B1} = I_{B2} = -15mA$	
Fall Time	t _f		30	ns	IB1 = IB2 = - TOTTIA	

Notes: 7. Short duration pulse test used to minimize self-heating effect.



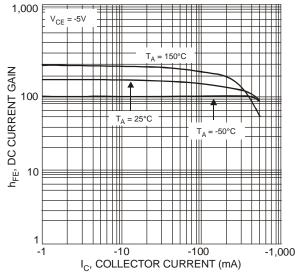


Fig. 2 Typical DC Current Gain vs. Collector Current

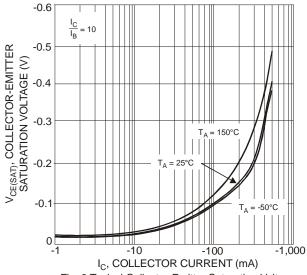


Fig. 3 Typical Collector-Emitter Saturation Voltage vs. Collector Current

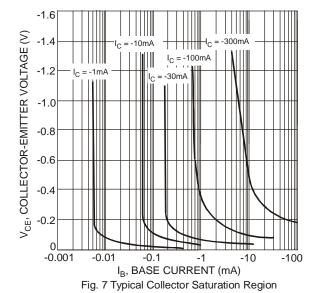


Fig. 4 Typical Base-Emitter Saturation Voltage vs. Collector Current

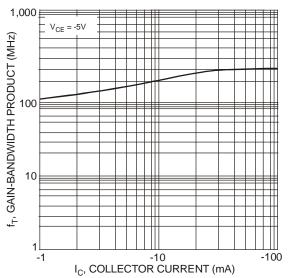


Fig. 6 Typical Gain-Bandwidth Product vs. Collector Current

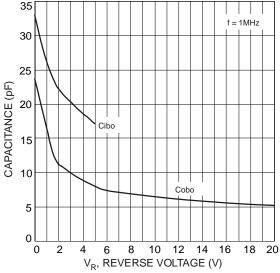
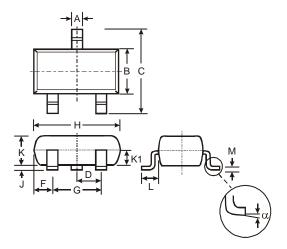


Fig. 5 Typical Capacitance Characteristics

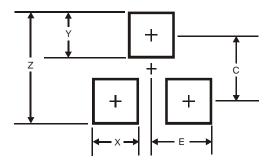


Package Outline Dimensions



	SOT23						
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.903	1.10	1.00				
K1	-	-	0.400				
L	0.45	0.61	0.55				
M	0.085	0.18	0.11				
α	0°	8°	-				
All	All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)				
Z	2.9				
X	0.8				
Y	0.9				
C	2.0				
E	1.35				



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